



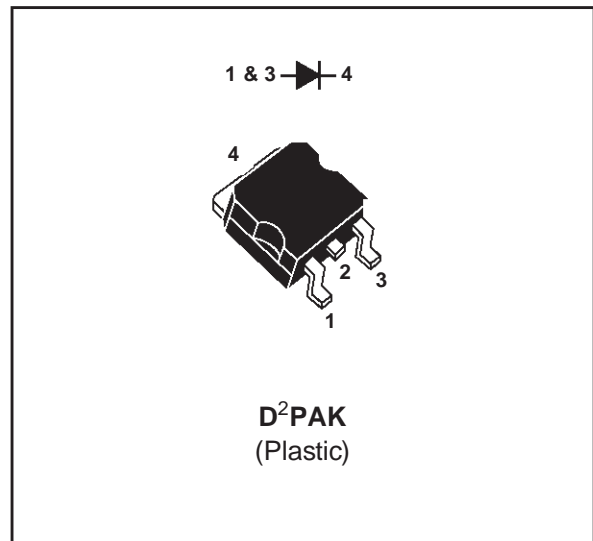
## HIGH EFFICIENCY FAST RECOVERY DIODES

### MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	25 A
$V_{RRM}$	200 V
$t_{rr}$	50 ns
$V_F$	0.85 V

### FEATURES AND BENEFITS

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD AND REVERSE RECOVERY TIME
- HIGH SURGE CURRENT CAPABILITY
- SMD PACKAGE



### DESCRIPTION

Single rectifier suited for switchmode power supply and high frequency DC to DC converters. Packaged in D<sup>2</sup>PAK, this surface mount device is intended for use in high frequency inverters, free wheeling and polarity protection applications.

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	200	V
$I_{F(RMS)}$	RMS forward current	50	A
$I_{F(AV)}$	Average forward current	$T_c=125^{\circ}C$ $\delta = 0.5$	25 A
$I_{FSM}$	Surge non repetitive forward current	$t_p=10ms$ sinusoidal	200 A
$I_{FRM}$	Repetitive peak forward current	$t_p = 5\mu s$ $f = 5 kHz$	310 A
$T_{stg}$ $T_j$	Storage and junction temperature range	- 40 to + 150	$^{\circ}C$

## BYW77G-200

### THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	1	°C/W

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> *	Reverse leakage current	V <sub>R</sub> = V <sub>RRM</sub>	T <sub>j</sub> = 25°C			25	μA
			T <sub>j</sub> = 100°C			2.5	mA
V <sub>F</sub> **	Forward voltage drop	I <sub>F</sub> = 20 A	T <sub>j</sub> = 125°C			0.85	V
		I <sub>F</sub> = 40 A	T <sub>j</sub> = 125°C			1.00	
		I <sub>F</sub> = 40 A	T <sub>j</sub> = 25°C			1.15	

Pulse test : \* t<sub>p</sub> = 5 ms, δ < 2 %

\*\* t<sub>p</sub> = 380 μs, δ < 2 %

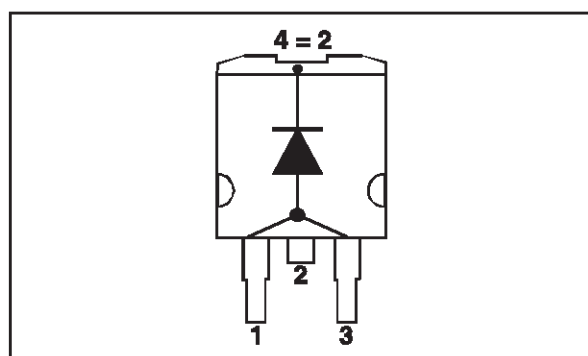
To evaluate the conduction losses use the following equation :

$$P = 0.65 \times I_{F(AV)} + 0.0075 I_{F(RMS)}^2$$

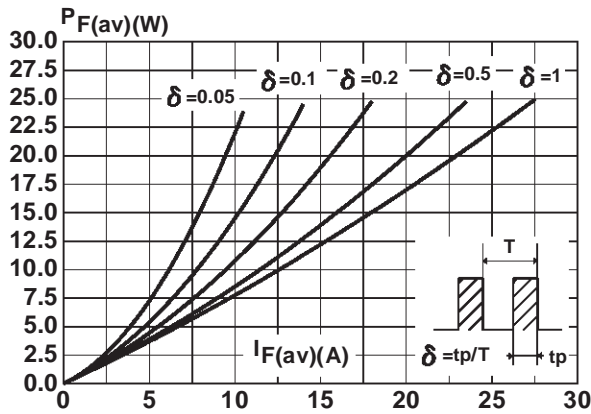
### RECOVERY CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25°C	I <sub>F</sub> = 0.5A			35	ns
		I <sub>rr</sub> = 0.25 A	I <sub>R</sub> = 1A				
t <sub>fr</sub>	Forward recovery time	T <sub>j</sub> = 25°C	I <sub>F</sub> = 1A		10		ns
		dI <sub>F</sub> /dt = 100A/μs	V <sub>FR</sub> = 1.1 x V <sub>F</sub> max				
V <sub>FP</sub>	Peak forward voltage	T <sub>j</sub> = 25°C	I <sub>F</sub> = 1A		1.5		V
		dI <sub>F</sub> /dt = 100A/μs					

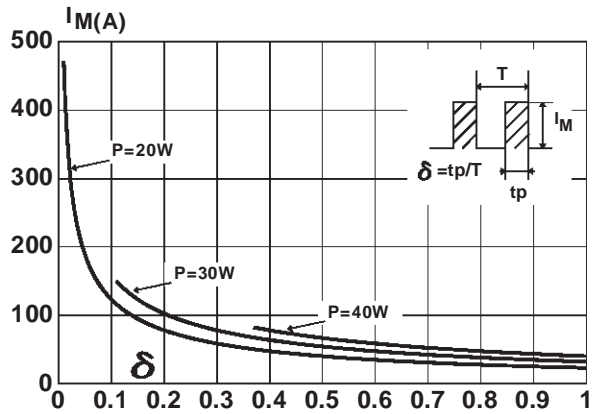
### PIN OUT configuration in D<sup>2</sup>PAK:



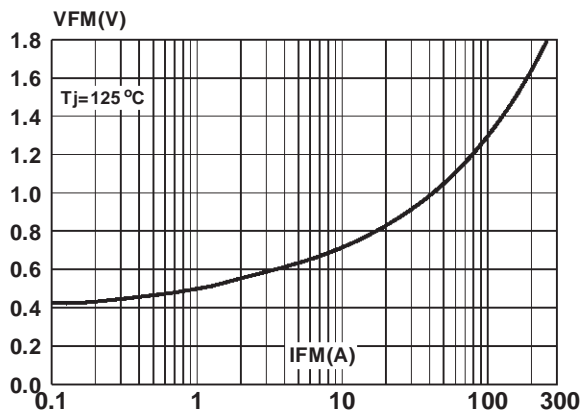
**Fig.1** : Average forward power dissipation versus average forward current.



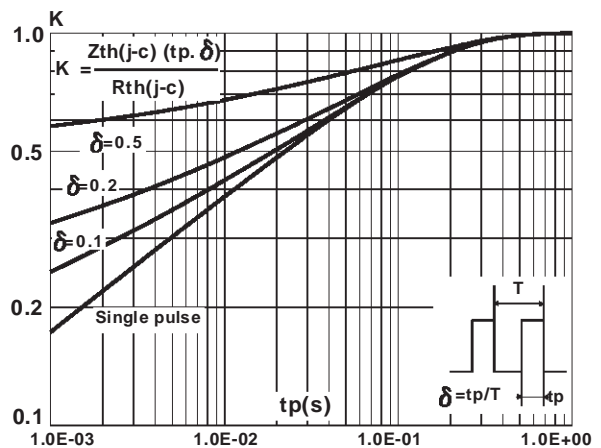
**Fig.2** : Peak current versus form factor.



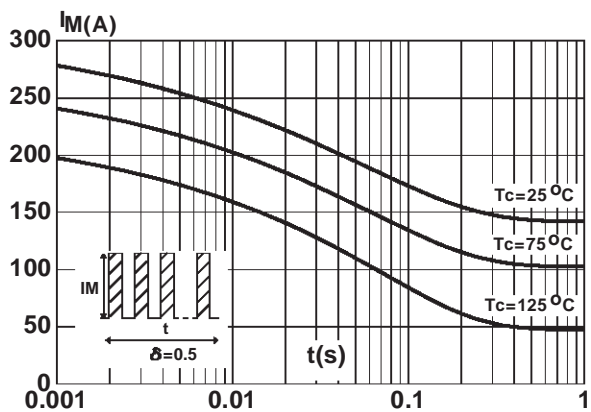
**Fig.3** : Forward voltage drop versus forward current (maximum values).



**Fig.4** : Relative variation of thermal impedance junction to case versus pulse duration.



**Fig.5** : Non repetitive surge peak forward current versus overload duration.



**Fig.6** : Average current versus ambient temperature. ( $\delta = 0.5$ )

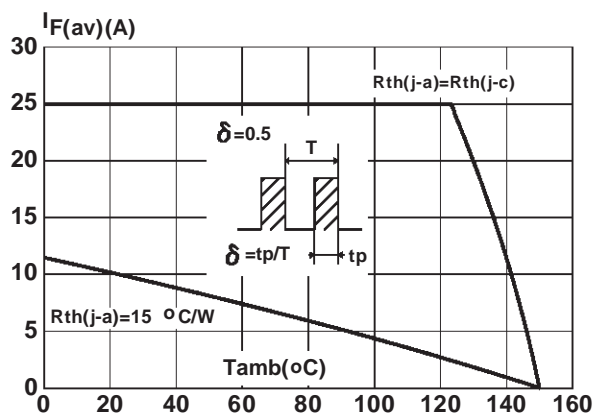


Fig.7 : Junction capacitance versus reverse voltage applied (Typical values).

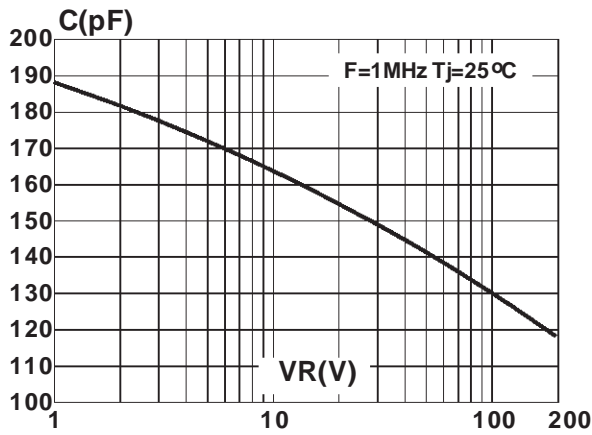


Fig.8 : Reverse recovery charges versus  $dI_F/dt$ .

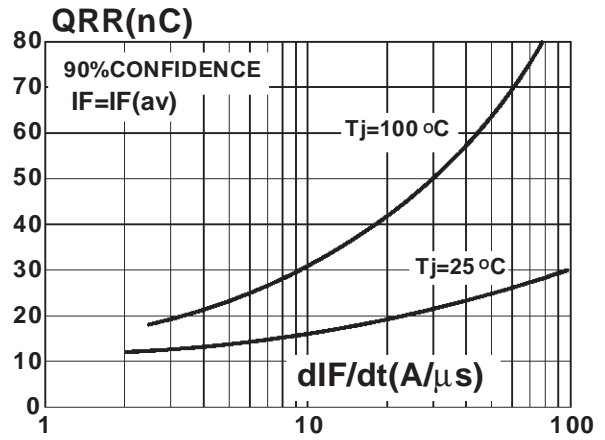


Fig.9 : Peak reverse current versus  $dI_F/dt$ .

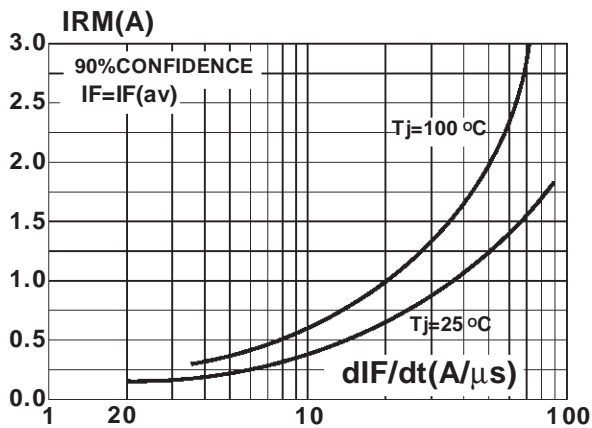
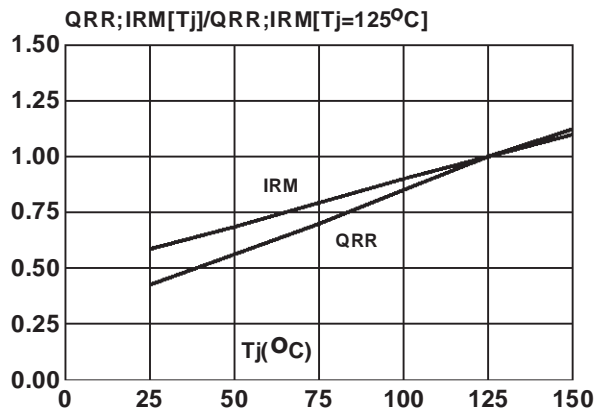
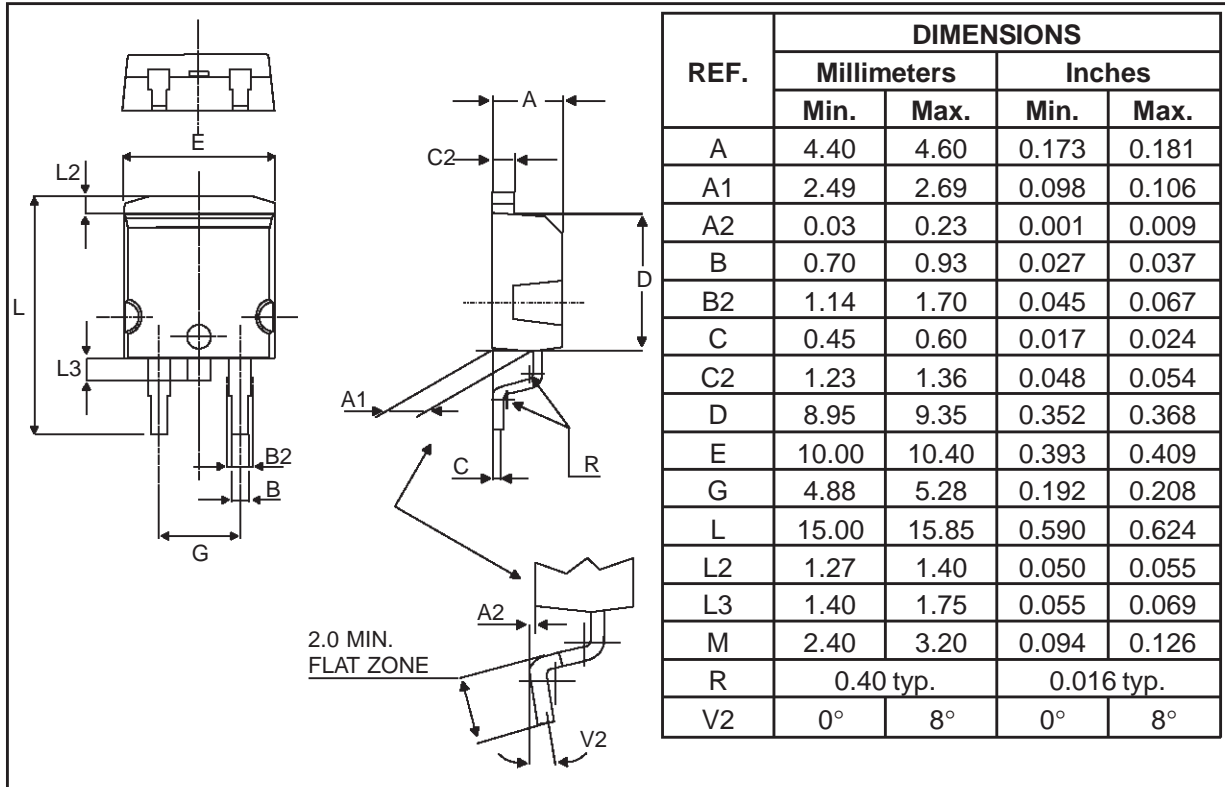


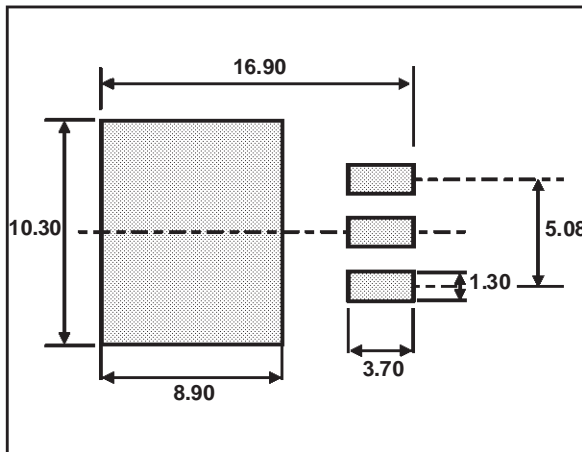
Fig.10 : Dynamic parameters versus junction temperature.



**PACKAGE MECHANICAL DATA**  
D<sup>2</sup>PAK (Plastic)



**FOOT PRINT (in millimeters)**



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